IGBT - Field Stop 600 V, 60 A

FGH60N60SMD

Description

Using novel field stop IGBT technology, ON Semiconductor's new series of field stop 2nd generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

Features

- Maximum Junction Temperature: $T_J = 175$ °C
- Positive Temperature Co-efficient for easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.9 \text{ V (Typ.)} @ I_C = 60 \text{ A}$
- High Input Impedance
- Fast Switching: E_{OFF} = 7.5 uJ/A
- Tightened Parameter Distribution
- This Device is Pb-Free and is RoHS Compliant

Applications

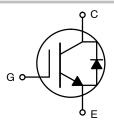
• Solar Inverter, UPS, Welder, PFC, Telecom, ESS

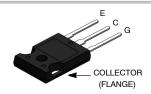


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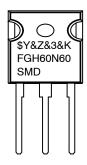
V _{CES}	Ic
600 V	60 A





TO-247-3LD CASE 340CK

MARKING DIAGRAM



\$Y = ON Semiconductor Logo &Z = Assembly Plant Code &3 = Numeric Date Code

&K = Lot Code

FGH60N60SMD = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Symbol	Description		Ratings	Unit
V _{CES}	Collector to Emitter Voltage		600	V
V _{GES}	Gate to Emitter Voltage		±20	V
	Transient Gate to Emitter Voltage		±30	V
Ic	Collector Current	T _C = 25°C	120	Α
		T _C = 100°C	60	Α
I _{CM} (Note 1)	Pulsed Collector Current		180	Α
I _F	Diode Forward Current	T _C = 25°C	60	Α
		T _C = 100°C	30	А
I _{FM} (Note 1)	Pulsed Diode Maximum Forward Current		180	Α
P _D	Maximum Power Dissipation	Maximum Power Dissipation $T_C = 25^{\circ}C$		W
	T _C = 100°C		300	W
TJ	Operating Junction Temperature		-55 to +175	°C
T _{STG}	Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case	_	0.25	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	1.1	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Qty per Tube
FGH60N60SMD	FGH60N60SMD	TO-247	Tube	N/A	N/A	30

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
FF CHARACT	ERISTICS	•	•	•		
BV _{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0 \text{ V, } I_{C} = 250 \mu\text{A}$	600	-	_	V
$\Delta BV_{CES} / \Delta T_{J}$	Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0 \text{ V}, I_{C} = 250 \mu A$	-	0.6	-	V/°C
I _{CES}	Collector Cut-Off Current	V _{CE} = V _{CES} , V _{GE} = 0 V	-	-	250	μΑ
I _{GES}	G-E Leakage Current	V _{GE} = V _{GES} , V _{CE} = 0 V	_	-	±400	nA
N CHARACTE	ERISTICS				-	
V _{GE(th)}	G-E Threshold Voltage	$I_C = 250 \mu A, V_{CE} = V_{GE}$	3.5	4.5	6.0	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 60 A, V _{GE} = 15 V,	-	1.9	2.5	V
		I _C = 60 A, V _{GE} = 15 V, T _C = 175°C	_	2.1	-	٧
YNAMIC CHA	RACTERISTICS		•	•		•
C _{ies}	Input Capacitance	V _{CE} = 30 V, V _{GE} = 0 V,	-	2915	_	pF
C _{oes}	Output Capacitance	f = 1 MHz	_	270	_	pF
C _{res}	Reverse Transfer Capacitance	1	-	85	-	pF
WITCHING CH	HARACTERISTICS	•	•	•		•
T _{d(on)}	Turn-On Delay Time	$V_{CC} = 400 \text{ V}, I_{C} = 60 \text{ A},$	-	18	27	ns
T _r	Rise Time	$R_G = 3 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$	_	47	70	ns
T _{d(off)}	Turn-Off Delay Time	7	-	104	146	ns
T _f	Fall Time		_	50	68	ns
E _{on}	Turn-On Switching Loss		_	1.26	1.94	mJ
E _{off}	Turn-Off Switching Loss	7	_	0.45	0.6	mJ
E _{ts}	Total Switching Loss	7	-	1.71	2.54	mJ
T _{d(on)}	Turn-On Delay Time	$V_{CC} = 400 \text{ V}, I_C = 60 \text{ A},$	-	18	_	ns
T _r	Rise Time	$R_G = 3 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 175^{\circ}C$	_	41	_	ns
T _{d(off)}	Turn-Off Delay Time	7	_	115	_	ns
T _f	Fall Time	7	-	48	-	ns
E _{on}	Turn-On Switching Loss		-	2.1	=	mJ
E _{off}	Turn-Off Switching Loss		-	0.78	_	mJ
E _{ts}	Total Switching Loss		-	2.88	-	mJ
Q_g	Total Gate Charge	V _{CE} = 400 V, I _C = 60 A, V _{GE} = 15 V	-	189	284	nC
Q _{ge}	Gate to Emitter Charge	VGE - 15 V	-	20	30	nC
Q _{gc}	Gate to Collector Charge		-	91	137	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions		Min	Тур	Max	Unit
V_{FM}	Diode Forward Voltage	I _F = 30 A	T _C = 25°C	-	2.1	2.7	V
			T _C = 175°C	-	1.7	-	
E _{rec}	Reverse Recovery Energy	I _F = 30 A, di _F /dt = 200 A/μs	T _C = 175°C	-	79	_	uJ
T _{rr}	Diode Reverse Recovery Time	uif/ut = 200 Λ/μο	T _C = 25°C	-	30	39	ns
			T _C = 175°C	-	72	-	
Q _{rr}	Diode Reverse Recovery Charge		T _C = 25°C	-	44	62	nC
			T _C = 175°C	-	238	_	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

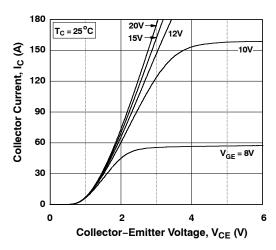


Figure 1. Typical Output Characteristics

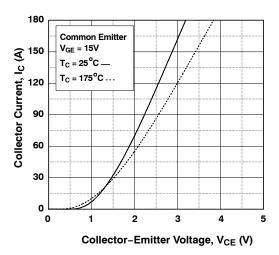


Figure 3. Typical Saturation Voltage Characteristics

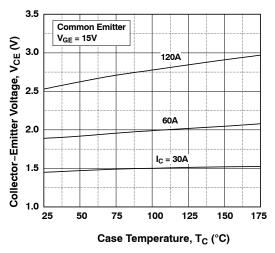


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

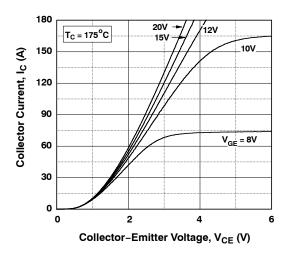


Figure 2. Typical Output Characteristics

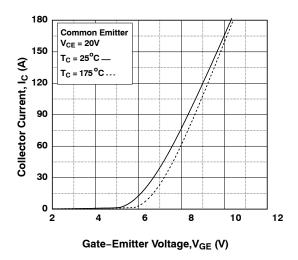


Figure 4. Transfer Characteristics

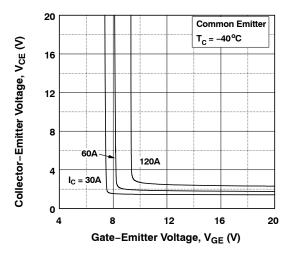


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

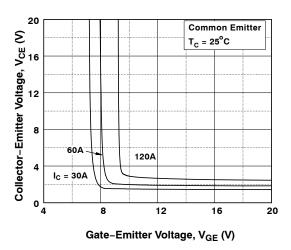


Figure 7. Saturation Voltage vs. V_{GE}

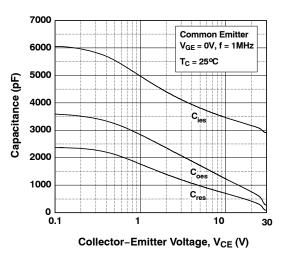


Figure 9. Capacitance Characteristics

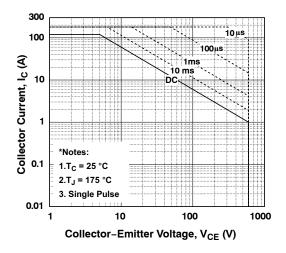


Figure 11. SOA Characteristics

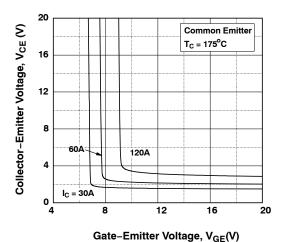


Figure 8. Saturation Voltage vs. V_{GE}

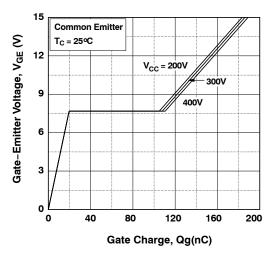


Figure 10. Gate Charge Characteristics

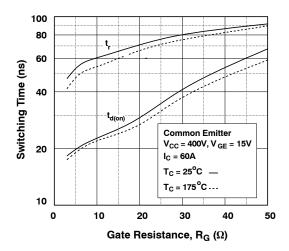


Figure 12. Turn-on Characteristics vs. Gate Resistance

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

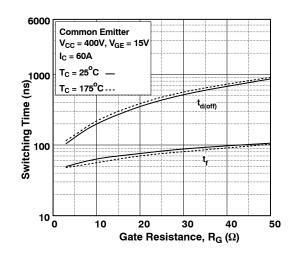


Figure 13. Turn-off Characteristics vs. Gate Resistance

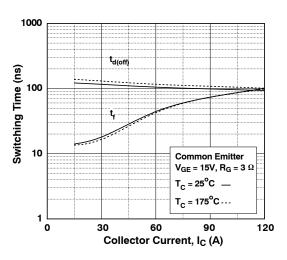


Figure 15. Turn-off Characteristics vs. Collector Current

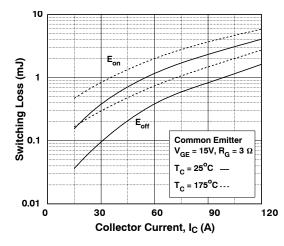


Figure 17. Switching Loss vs. Collector Current

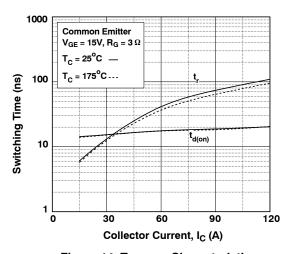


Figure 14. Turn-on Characteristics vs. Collector Current

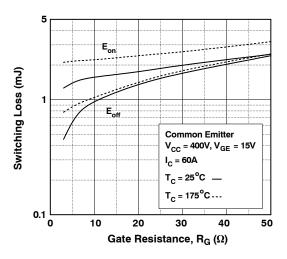


Figure 16. Switching Loss vs.
Gate Resistance

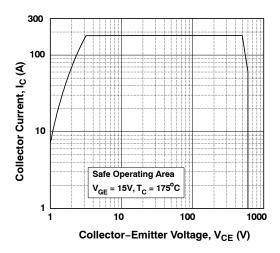


Figure 18. Turn Off Switching SOA Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

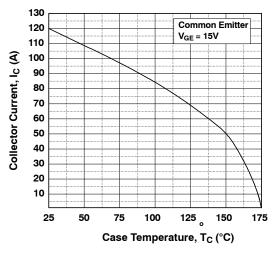


Figure 19. Current Derating

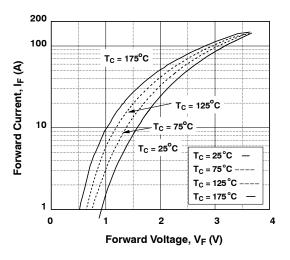


Figure 21. Forward Characteristics

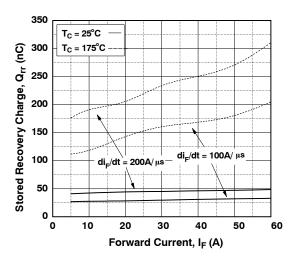


Figure 23. Stored Charge

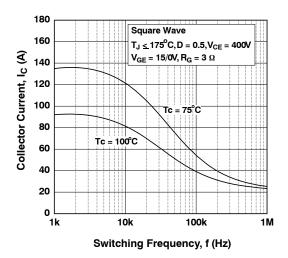


Figure 20. Load Current vs. Frequency

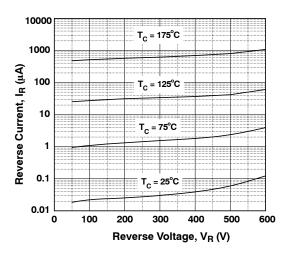


Figure 22. Reverse Current

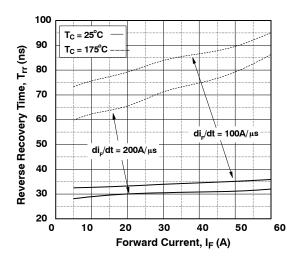


Figure 24. Reverse Recovery Time

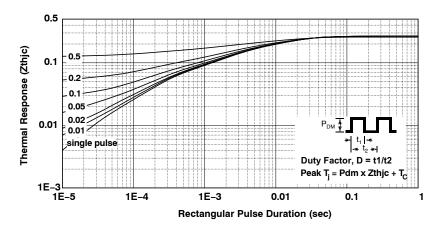


Figure 25. Transient Thermal Impedance of IGBT

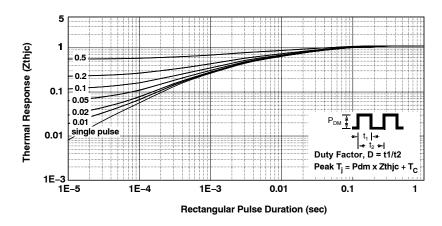
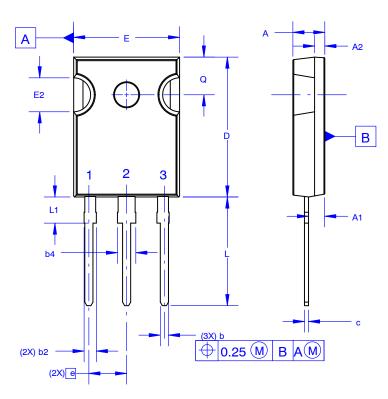


Figure 26. Transient Thermal Impedance of Diode

TO-247-3LD SHORT LEAD

CASE 340CK ISSUE A





- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code

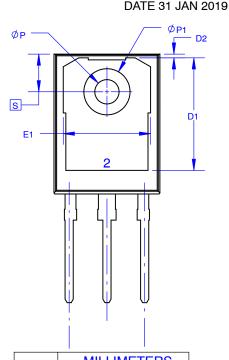
A = Assembly Location

Y = Year

WW = Work Week

ZZ = Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



DIM	MILLIMETERS				
DIIVI	MIN	NOM	MAX		
Α	4.58	4.70	4.82		
A1	2.20	2.40	2.60		
A2	1.40	1.50	1.60		
b	1.17	1.26	1.35		
b2	1.53	1.65	1.77		
b4	2.42	2.54	2.66		
С	0.51	0.61	0.71		
D	20.32	20.57	20.82		
D1	13.08	~	~		
D2	0.51	0.93	1.35		
E	15.37	15.62	15.87		
E1	12.81	~	~		
E2	4.96	5.08	5.20		
е	~	5.56	~		
L	15.75	16.00	16.25		
L1	3.69	3.81	3.93		
ØΡ	3.51	3.58	3.65		
Ø P1	6.60	6.80	7.00		
Q	5.34	5.46	5.58		
S	5.34	5.46	5.58		

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DESCRIPTION:	TO-247-3LD SHORT LEAD		PAGE 1 OF 1		

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 TIG058E8-TL-H
 VS-CPV364M4KPBF
 NGTB25N120FL2WAG
 NGTG40N120FL2WG
 RJH60F3DPQ-A0#T0

 APT40GR120B2SCD10
 APT15GT120BRG
 APT20GT60BRG
 NGTB75N65FL2WAG
 NGTG15N120FL2WG
 IXA30RG1200DHGLB

 IXA40RG1200DHGLB
 APT70GR65B2DU40
 NTE3320
 IHFW40N65R5SXKSA1
 APT70GR120J
 APT35GP120JDQ2

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 IKFW50N65ES5XKSA1
 IKFW50N65EH5XKSA1
 IKFW40N65ES5XKSA1

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 IGW08T120FKSA1
 IGW75N60H3FKSA1
 HGTG40N60B3
 FGH60N60SMD_F085

 FGH75T65UPD
 STGWA15H120F2
 IKA10N60TXKSA1
 IHW20N120R5XKSA1
 RJH60D2DPP-M0#T2
 IKP20N60TXKSA1

 IHW20N65R5XKSA1
 IDW40E65D2FKSA1